

MITSUBISHI HVIGBT MODULES  
**CM800HB-66H**

2nd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

HIGH POWER SWITCHING USE  
**INSULATED TYPE**

**CM800HB-66H**



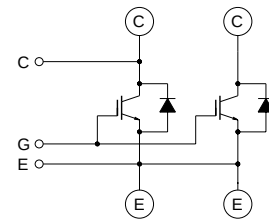
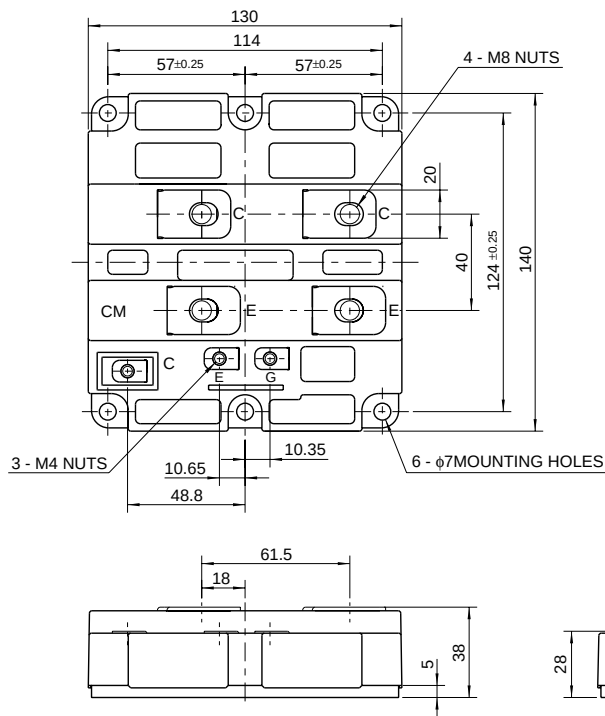
- Ic .....800A
- VCES ..... 3300V
- Insulated Type
- 1-element in a pack

**APPLICATION**

Inverters, Converters, DC choppers, Induction heating, DC to DC converters.

**OUTLINE DRAWING & CIRCUIT DIAGRAM**

Dimensions in mm



CIRCUIT DIAGRAM

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Mar. 2003



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INSULATED TYPE

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MAXIMUM RATINGS ( $T_j = 25^\circ\text{C}$ )

| Symbol            | Item                          | Conditions                                                 | Ratings         | Unit             |
|-------------------|-------------------------------|------------------------------------------------------------|-----------------|------------------|
| $V_{CES}$         | Collector-emitter voltage     | $V_{GE} = 0V$                                              | 3300            | V                |
| $V_{GES}$         | Gate-emitter voltage          | $V_{CE} = 0V$                                              | $\pm 20$        | V                |
| $I_C$             | Collector current             | DC, $T_c = 100^\circ\text{C}$                              | 800             | A                |
| $I_{CM}$          |                               | Pulse (Note 1)                                             | 1600            | A                |
| $I_E$ (Note 2)    | Emitter current               |                                                            | 800             | A                |
| $I_{EM}$ (Note 2) |                               | Pulse (Note 1)                                             | 1600            | A                |
| $P_C$ (Note 3)    | Maximum collector dissipation | $T_c = 25^\circ\text{C}$ , IGBT part                       | 10400           | W                |
| $T_j$             | Junction temperature          | —                                                          | $-40 \sim +150$ | $^\circ\text{C}$ |
| $T_{stg}$         | Storage temperature           | —                                                          | $-40 \sim +125$ | $^\circ\text{C}$ |
| $V_{iso}$         | Isolation voltage             | Charged part to base plate, rms, sinusoidal, AC 60Hz 1min. | 6000            | V                |
| —                 | Mounting torque               | Main terminals screw M8                                    | 6.67 ~ 13.00    | N·m              |
|                   |                               | Mounting screw M6                                          | 2.84 ~ 6.00     | N·m              |
|                   |                               | Auxiliary terminals screw M4                               | 0.88 ~ 2.00     | N·m              |
| —                 | Mass                          | Typical value                                              | 1.5             | kg               |

ELECTRICAL CHARACTERISTICS ( $T_j = 25^\circ\text{C}$ )

| Symbol                  | Item                                 | Conditions                                                                                                              | Limits |       |       | Unit          |
|-------------------------|--------------------------------------|-------------------------------------------------------------------------------------------------------------------------|--------|-------|-------|---------------|
|                         |                                      |                                                                                                                         | Min    | Typ   | Max   |               |
| $I_{CES}$               | Collector cutoff current             | $V_{CE} = V_{CES}$ , $V_{GE} = 0V$                                                                                      | —      | —     | 10    | mA            |
| $V_{GE(th)}$            | Gate-emitter threshold voltage       | $I_C = 80\text{mA}$ , $V_{CE} = 10V$                                                                                    | 4.5    | 6.0   | 7.5   | V             |
| $I_{GES}$               | Gate-leakage current                 | $V_{GE} = V_{GES}$ , $V_{CE} = 0V$                                                                                      | —      | —     | 0.5   | $\mu\text{A}$ |
| $V_{CE(sat)}$           | Collector-emitter saturation voltage | $T_j = 25^\circ\text{C}$                                                                                                | —      | 3.80  | 4.94  | V             |
|                         |                                      | $T_j = 125^\circ\text{C}$                                                                                               | —      | 4.00  | —     |               |
| $C_{ies}$               | Input capacitance                    | $V_{CE} = 10V$<br>$V_{GE} = 0V$                                                                                         | —      | 120   | —     | nF            |
| $C_{oes}$               | Output capacitance                   |                                                                                                                         | —      | 12.0  | —     | nF            |
| $C_{res}$               | Reverse transfer capacitance         |                                                                                                                         | —      | 3.6   | —     | nF            |
| $Q_G$                   | Total gate charge                    | $V_{CC} = 1650V$ , $I_C = 800A$ , $V_{GE} = 15V$                                                                        | —      | 5.7   | —     | $\mu\text{C}$ |
| $t_d(\text{on})$        | Turn-on delay time                   | $V_{CC} = 1650V$ , $I_C = 800A$<br>$V_{GE1} = V_{GE2} = 15V$<br>$R_G = 2.5\Omega$<br>Resistive load switching operation | —      | —     | 1.60  | $\mu\text{s}$ |
| $t_r$                   | Turn-on rise time                    |                                                                                                                         | —      | —     | 2.00  | $\mu\text{s}$ |
| $t_d(\text{off})$       | Turn-off delay time                  |                                                                                                                         | —      | —     | 2.50  | $\mu\text{s}$ |
| $t_f$                   | Turn-off fall time                   |                                                                                                                         | —      | —     | 1.00  | $\mu\text{s}$ |
| $V_{EC}(\text{Note 2})$ | Emitter-collector voltage            | $I_E = 800A$ , $V_{GE} = 0V$                                                                                            | —      | 2.80  | 3.64  | V             |
| $t_{rr}$ (Note 2)       | Reverse recovery time                | $I_E = 800A$ ,                                                                                                          | —      | —     | 1.40  | $\mu\text{s}$ |
| $Q_{rr}$ (Note 2)       | Reverse recovery charge              | die / dt = $-1600A / \mu\text{s}$ (Note 1)                                                                              | —      | 270   | —     | $\mu\text{C}$ |
| $R_{th(j-c)Q}$          | Thermal resistance                   | Junction to case, IGBT part                                                                                             | —      | —     | 0.012 | K/W           |
| $R_{th(j-c)R}$          |                                      | Junction to case, FWDi part                                                                                             | —      | —     | 0.024 | K/W           |
| $R_{th(c-f)}$           | Contact thermal resistance           | Case to fin, conductive grease applied                                                                                  | —      | 0.008 | —     | K/W           |

Note 1. Pulse width and repetition rate should be such that the device junction temp. ( $T_j$ ) does not exceed  $T_{jmax}$  rating.2.  $I_E$ ,  $V_{EC}$ ,  $t_{rr}$ ,  $Q_{rr}$  and die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.3. Junction temperature ( $T_j$ ) should not increase beyond  $150^\circ\text{C}$ .

4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

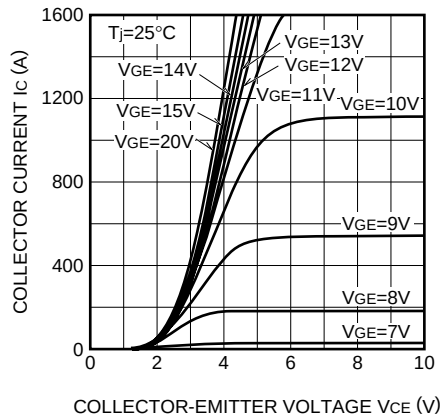
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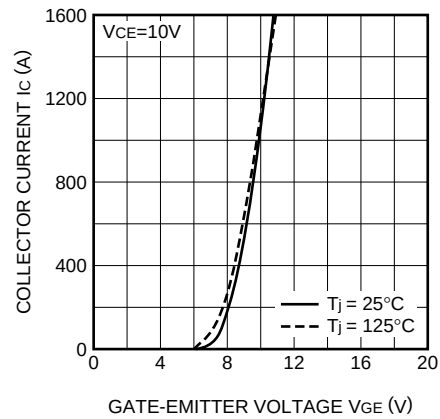
HIGH POWER SWITCHING USE  
INSULATED TYPE

## PERFORMANCE CURVES

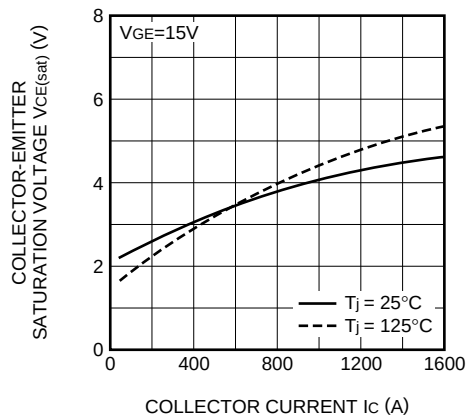
OUTPUT CHARACTERISTICS  
(TYPICAL)



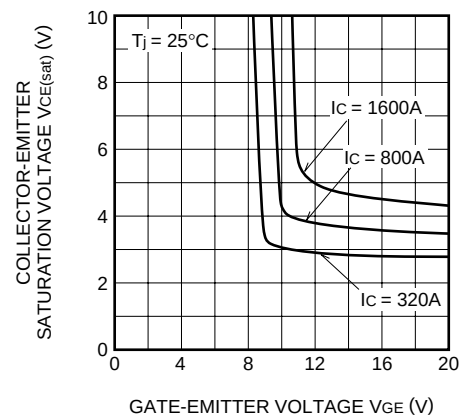
TRANSFER CHARACTERISTICS  
(TYPICAL)



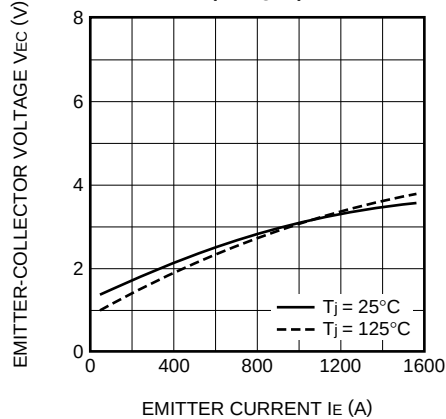
COLLECTOR-EMITTER SATURATION  
VOLTAGE CHARACTERISTICS  
(TYPICAL)



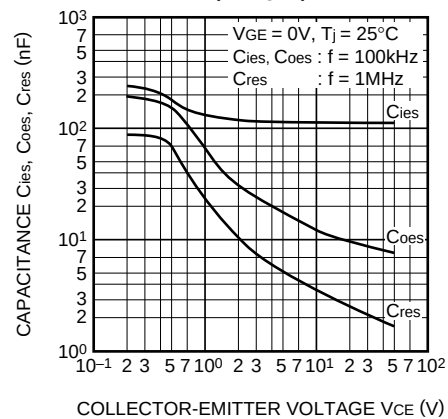
COLLECTOR-EMITTER SATURATION  
VOLTAGE CHARACTERISTICS  
(TYPICAL)



FREE-WHEEL DIODE  
FORWARD CHARACTERISTICS  
(TYPICAL)

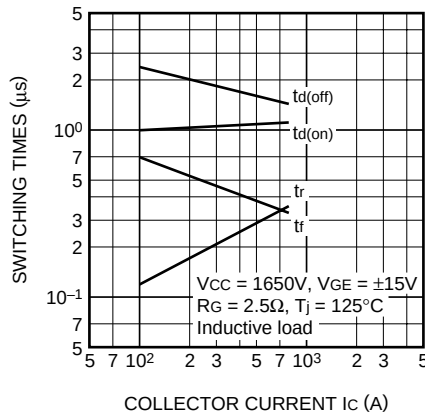
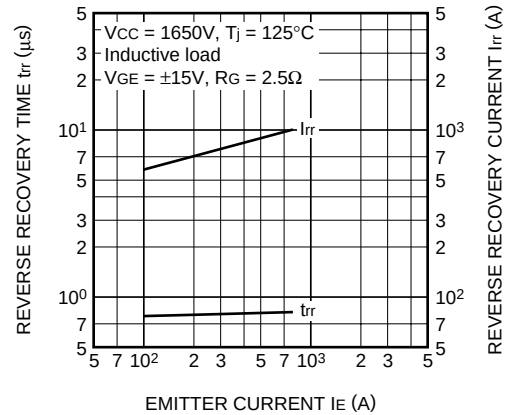
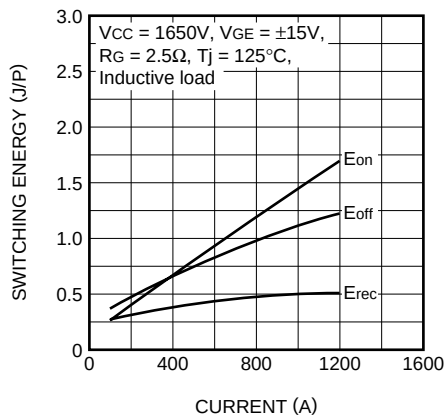
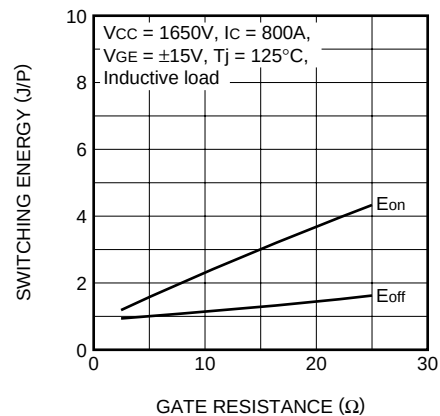
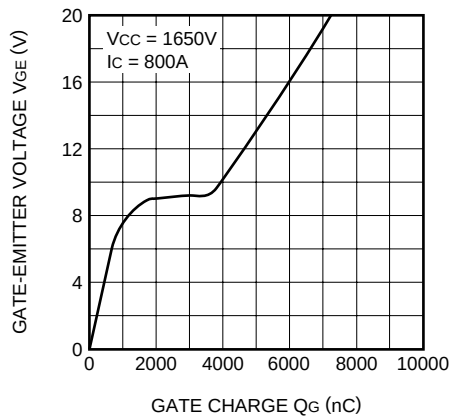


CAPACITANCE CHARACTERISTICS  
(TYPICAL)



## CM800HB-66H

2nd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

HIGH POWER SWITCHING USE  
INSULATED TYPEHALF-BRIDGE  
SWITCHING TIME CHARACTERISTICS  
(TYPICAL)REVERSE RECOVERY CHARACTERISTICS  
OF FREE-WHEEL DIODE  
(TYPICAL)HALF-BRIDGE  
SWITCHING ENERGY CHARACTERISTICS  
(TYPICAL)HALF-BRIDGE  
SWITCHING ENERGY CHARACTERISTICS  
(TYPICAL)GATE CHARGE CHARACTERISTICS  
(TYPICAL)TRANSIENT THERMAL  
IMPEDANCE CHARACTERISTICS